



HD01 - HD06

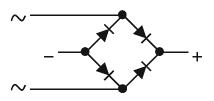
0.8A SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER

Features and Benefits

- Glass Passivated Die Construction
- Low Forward Voltage Drop
- Surge Overload Rating to 30A Peak
- Ideally Suited for Automated Assembly
- Miniature Package Saves Space on PC Boards
- UL Listed Under Recognized Component Index, File Number E94661
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)

Mechanical Data

- Case: MiniDIP
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Tin. Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Polarity: As Marked on Case
- Marking: Product Type Marking Code, Date Code & Polarity Markings
- Weight: 0.125 grams (Approximate)



Equivalent Circuit

Ordering Information (Note 3)

Part Number*	Packaging	Shipping
HDxx-T	MiniDIP	3k/Tape & Reel, 13-inch

*xx = Device type, e.g. HD02-T or HD04-T, etc.

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- $3. For packaging details, go to our website at \verb|https://www.diodes.com/design/support/packaging/diodes-packaging/.$

Marking Information



HDxx = Product Type Marking Code (ex: HD04) YM = Date Code Marking Y = Last Digit of the Year

M = See Month/Code Table Below

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	HD01	HD02	HD04	HD06	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RMM} V _{RWM} V _{DC}	100	200	400	600	\ \
RMS Reverse Voltage	V _{RMS}	70	140	280	420	V
Average Forward Rectified Current (Note 4) @T _A = +40°C	Io		0	.8		Α
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}		3	0		Α

Thermal Characteristics

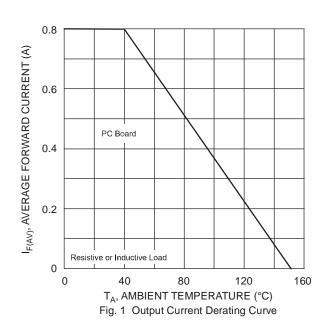
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 4)	$R_{ hetaJA}$	75	°C/W
Operating and Storage Temperature Range	T_J,T_STG	-55 to +150	°C

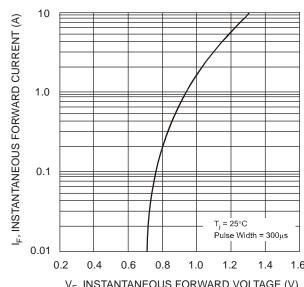
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Instantaneous Voltage Drop @ 0.4A (Per Element)	V_{F}	1.0	V
Peak Reverse Current at Rated @T _A = +25°C DC Blocking Voltage (Per Element) @T _A = +125°C	I _R	5.0 500	μΑ
Typical Total Capacitance (Per Element) (Note 5)	Ст	10	pF

Notes:

- 4. Mounted on PC Board.
- 5. Measured at 1.0MHz and applied reverse voltage of 4.0V.





V_F, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 2 Typical Forward Characteristics (per element)



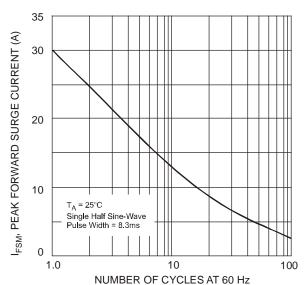
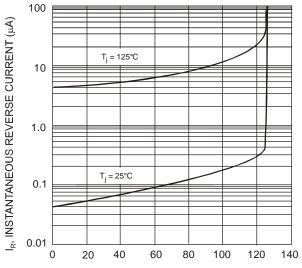


Fig. 3 Maximum Peak Forward Surge Current (per element)



PERCENT OF RATED PEAK REVERSE VOLTAGE (%) Fig. 5 Typical Reverse Characteristics (per element)

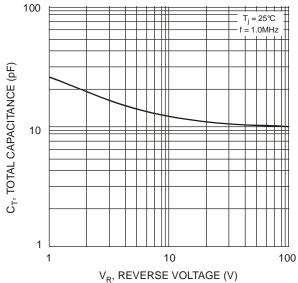


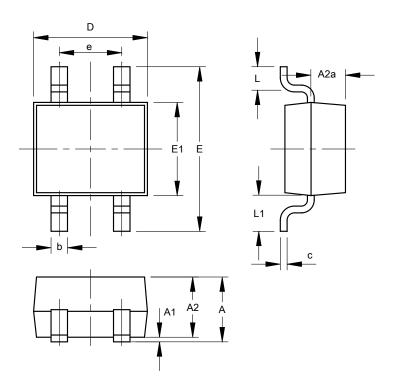
Fig. 4 Typical Total Capacitance (per element)



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

MiniDIP

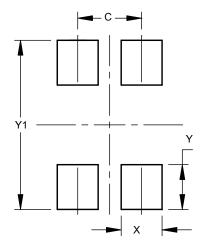


MiniDIP				
Dim	Min	Max		
Α		3.00		
A1		0.20		
A2	2.30	2.70		
A2a	1.20	1.60		
b	0.50	0.80		
С	0.15	0.35		
D	4.50	4.90		
Е		7.00		
E1	3.60	4.00		
е	2.30	2.70		
L	0.70	1.10		
L1	1.10	2.12		
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

MiniDIP



Dimensions	Value (in mm)		
С	2.50		
Χ	1.65		
Υ	1.80		
Y1	6.80		



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